Voltage Regulator – CMOS, Low Iq, Low Output

150 mA

NCP571, NCV571

The NCP571 series of fixed output low dropout linear regulators are designed for handheld communication equipment and portable battery powered applications which require low quiescent current. The NCP571 series features an ultra-low quiescent current of 4.0 μA. Each device contains a voltage reference unit, an error amplifier, a PMOS power transistor, resistors for setting output voltage, current limit, and temperature limit protection circuits.

The NCP571 has been designed to be used with low cost ceramic capacitors and requires a minimum output capacitor of 0.1 μF. The device is housed in the TSOP-5 or DFN6 surface mount package. Standard voltage versions are 0.8 V, 0.9 V, 1.0 V and 1.2 V.

Features

- Low Quiescent Current of 4.0 μA Typical
- Maximum Operating Voltage of 12 V
- Low Output Voltage Option down to 0.8 V
- High Accuracy Output Voltage of 3.0%
- Industrial Temperature Range of –40 °C to +85 °C (NCV571, T_A = –40 °C to +125 °C)
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These are Pb-Free Devices

Typical Applications

- Battery Powered Instruments
- Hand-Held Instruments
- Camcorders and Cameras

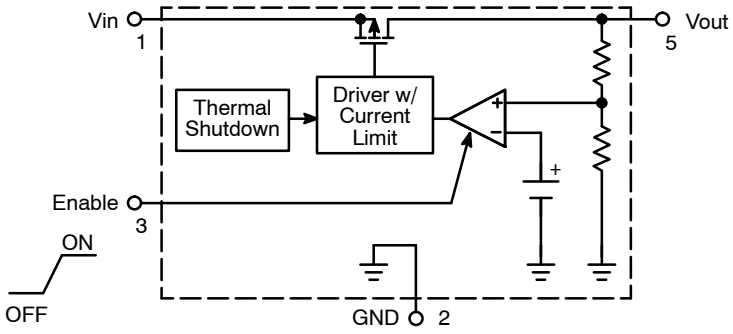


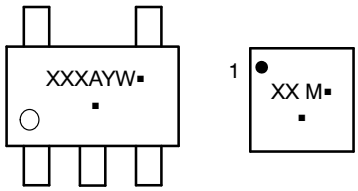
Figure 1. Representative Block Diagram



TSOP-5
SN SUFFIX
CASE 483

DFN6
MN SUFFIX
CASE 506BA

MARKING DIAGRAMS



XXX = Specific Device Code
A = Assembly Location
Y = Year
W = Work Week
M = Date Code
▪ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

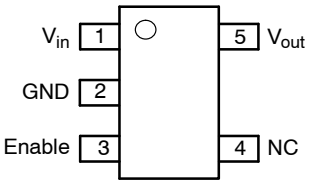
See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 9.

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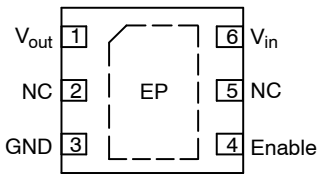
PIN CONNECTIONS

TSOP-5 package



(Top View)

DFN6 package



(Top View)

PIN FUNCTION DESCRIPTION

DFN6	TSOP-5	Pin Name	Description
1	5	V_{out}	Regulated output voltage.
2	4	NC	No Internal Connection. It is recommended to connect this pin to GND potential.
3	2	GND	Power supply ground.
4	3	Enable	This input is used to place the device into low-power standby. When this input is pulled low, the device is disabled. If this function is not used, Enable pin should be connected to V_{in}.
5	–	NC	No Internal Connection. It is recommended to connect this pin to GND potential.
6	1	V_{in}	Positive power supply input voltage.
EP	–	EP	No Internal Connection. It is recommended to connect this pin to GND potential.

MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Input Voltage		V_{in}	0 to 12	V
Enable Voltage		V_{EN}	−0.3 to V_{in} + 0.3	V
Output Voltage		V_{out}	−0.3 to V_{in} + 0.3	V
Power Dissipation		P_D	Internally Limited	W
Operating Junction Temperature		T_J	+150	°C
Operating Ambient Temperature NCV571	NCP571	T_A	−40 to +85 −40 to +125	°C
Storage Temperature		T_{stg}	−55 to +150	°C
ESD Capability, Human Body Model (Note 1)		ESD_{HBM}	2000	V
ESD Capability, Machine Mode (Note 1)		ESD_{MM}	200	V
ESD Capability, Charged Device Model (Note 1)		ESD_{CDM}	1000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. This device series contains ESD protection and exceeds the following tests:
   ESD Human Body Model tested per AEC−Q100−002 (EIA/JESD22−A114)
   ESD Machine Model tested per AEC-Q100-003 (EIA/JESD22-A115)
   ESD Charged Device Model tested per EIA/JES D22/C101, Field Induced Charge Model (Jedec Standard)
2. Latchup capability (85 °C) ±100 mA DC with trigger voltage.

THERMAL CHARACTERISTICS

Rating		Symbol	Test Conditions	Typical Value	Unit
Junction-to-Ambient	TSOP-5	$R_{\theta JA}$	1 oz Copper Thickness, 100 mm^2	250	°C/W
PSIJ-Lead 2	TSOP-5	Ψ_{J-L2}	1 oz Copper Thickness, 100 mm^2	68	°C/W
Junction-to-Ambient	DFN6	$R_{\theta JA}$	1 oz Copper Thickness, 100 mm^2	190	°C/W
PSIJ−Lead 2	DFN6	Ψ_{J-L2}	1 oz Copper Thickness, 100 mm^2	84	°C/W

NOTE: Single component mounted on an 80 x 80 x 1.5 mm FR4 PCB with stated copper head spreading area. Using the following boundary conditions as stated in EIA/JESD 51-1, 2, 3, 7, 12.

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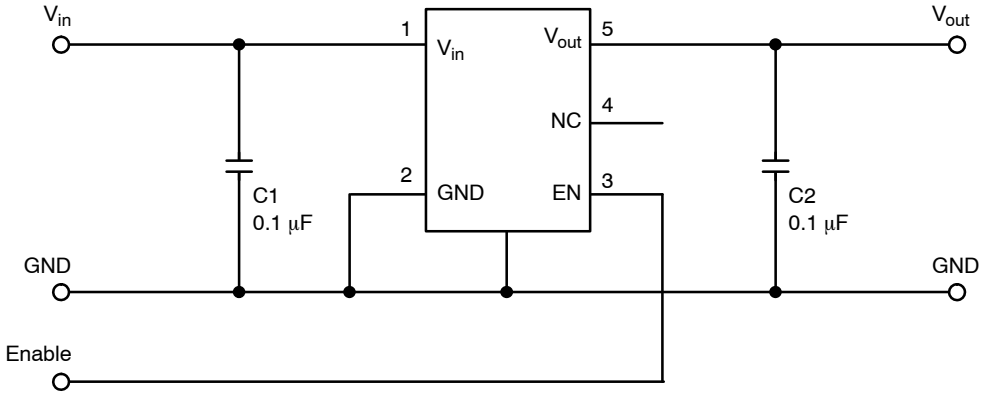


Figure 2. Typical Application Schematic for TSOP-5 Package

ELECTRICAL CHARACTERISTICS

(V_{in} = $V_{out(nom)}$ + 1.0 V, V_{EN} = V_{in}, C_{in} = 1.0 μF, C_{out} = 1.0 μF, T_A = 25 °C, unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Output Voltage (T_A = 25 °C, I_{out} = 10 mA) 0.8 V 0.9 V 1.0 V 1.2 V	V_{out}	− 3% 0.776 0.873 0.970 1.164	 0.8 0.9 1.0 1.2	+ 3% 0.824 0.927 1.030 1.236	V
Output Voltage (T_A = −40 °C to +85 °C for NCP571 or T_A = −40 °C to +125 °C for NCV571, I_{out} = 10 mA) (Note 5) 0.8 V 0.9 V 1.0 V 1.2 V	V_{out}	− 4% 0.768 0.864 0.960 1.152	 0.8 0.9 1.0 1.2	+ 4% 0.832 0.936 1.040 1.248	V
Line Regulation (V_{in} = V_{out} + 1.0 V to 12 V, I_{out} = 10 mA)	Reg_{line}	–	10	30	mV
Load Regulation (I_{out} = 10 mA to 150 mA, V_{in} = V_{out} + 2.0 V)	Reg_{load}	–	40	65	mV
Output Current (V_{out} = (V_{out} at I_{out} = 100 mA) − 3%) 0.8 V (V_{in} = 3.0 V) 0.9 V (V_{in} = 3.0 V) 1.0 V (V_{in} = 3.0 V) 1.2 V (V_{in} = 3.0 V)	$I_{o(nom)}$	 150 150 150 150	 – – – –	 – – – –	mA
Dropout Voltage (I_{out} = 10 mA, Measured at V_{out} - 3.0%) 0.8 V 0.9 V 1.0 V 1.2 V	V_{in}-V_{out}	 – – – –	 730 650 550 350	 850 750 650 450	mV
Quiescent Current (Enable Input = 0 V) (Enable Input = V_{in} = 3 V, I_{out} = 1.0 mA to 150 mA and V_{in} = Enable Input = 3 V, I_{out} = 150 mA)	I_Q	 – –	 0.1 4.0	 1.0 8.0	uA
Output Voltage Temperature Coefficient	T_c	–	100	–	ppm/°C
Enable Input Threshold Voltage (Voltage Increasing, Output Turns On, Logic High) (Voltage Decreasing, Output Turns Off, Logic Low)	$V_{th(en)}$	 1.3 –	 – –	 – 0.3	V
Output Short Circuit Current (V_{out} = 0 V) (Note 4) 0.8 V (V_{in} = 3.0 V) 0.9 V (V_{in} = 3.0 V) 1.0 V (V_{in} = 3.0 V) 1.2 V (V_{in} = 3.0 V)	$I_{out(max)}$	 160 160 160 160	 260 260 260 260	 600 600 600 600	mA

3. Maximum package power dissipation limits must be observed.

$$P_D = \frac{T_{J(max)} - T_A}{R_{\theta JA}}$$

4. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.

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5. NCP571 T_{low} = −40 °C T_{high} = +85 °C
   NCV571 T_{low} = −40 °C T_{high} = +125 °C.

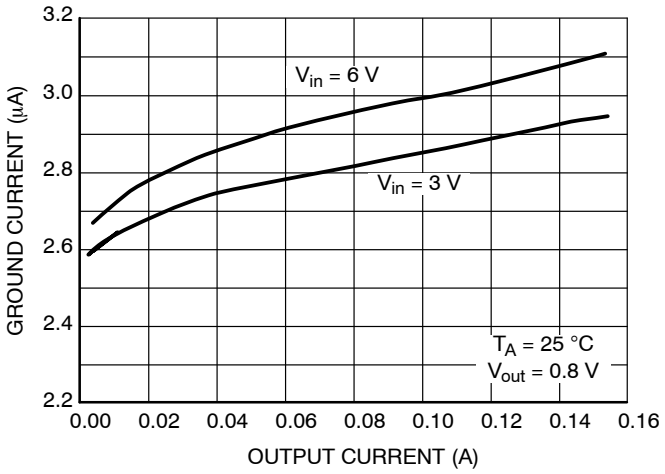


Figure 3. Ground Pin Current vs. Output Current

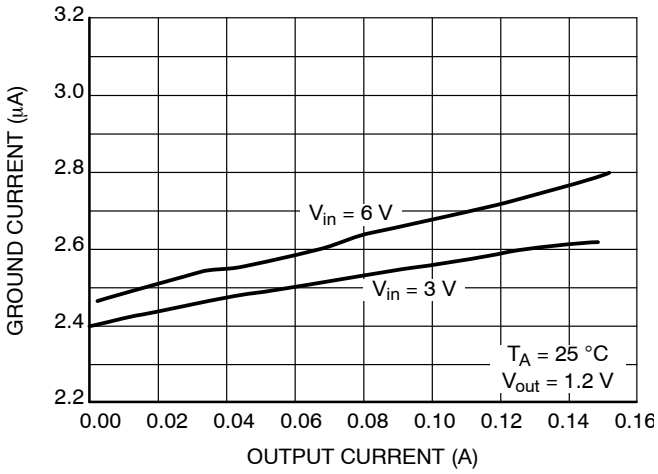


Figure 4. Ground Pin Current vs. Output Current

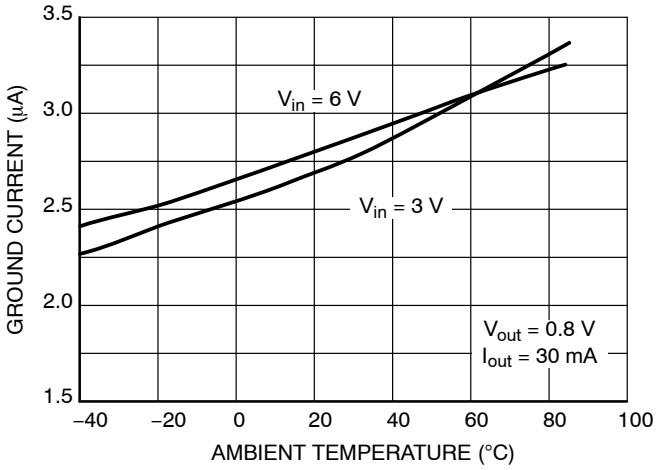


Figure 5. Ground Pin Current vs. Temperature

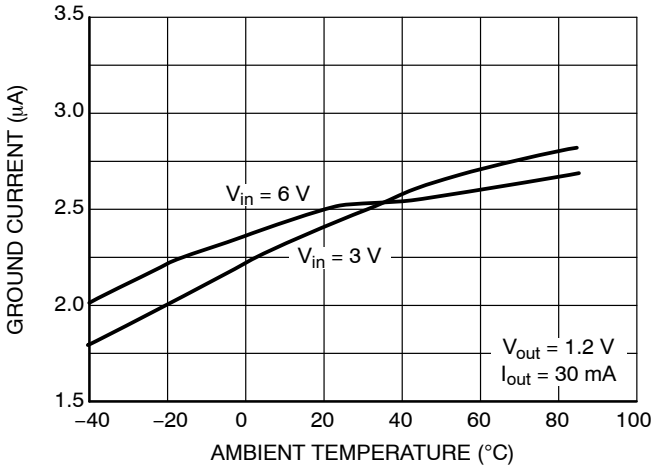


Figure 6. Ground Pin Current vs. Temperature

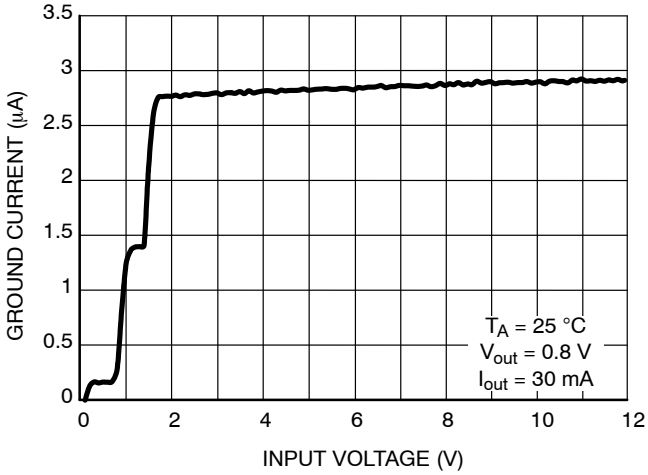


Figure 7. Ground Pin Current vs. Input Voltage

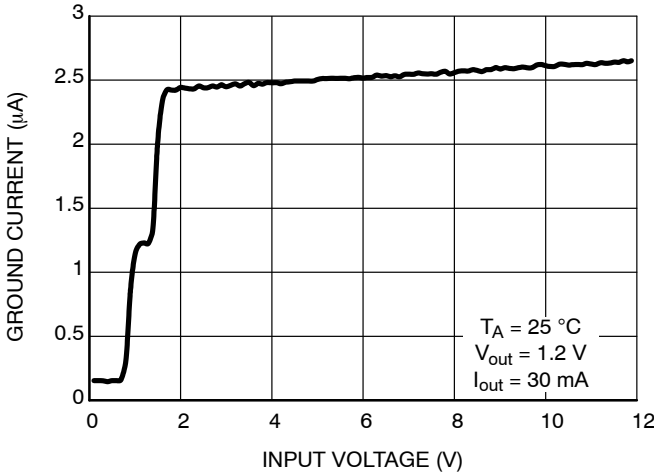


Figure 8. Ground Pin Current vs. Input Voltage

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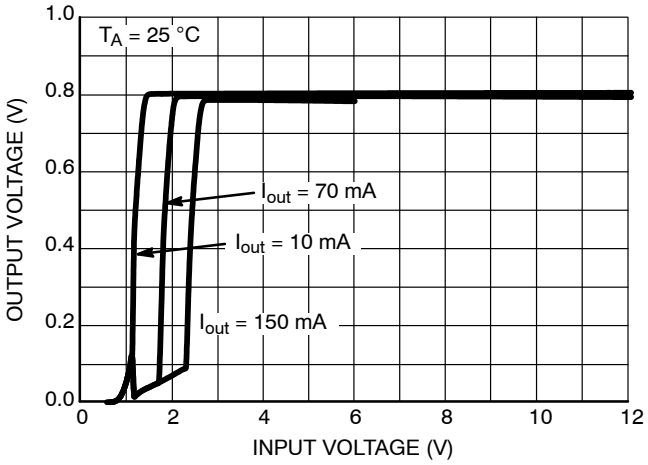


Figure 9. Output Voltage vs. Input Voltage

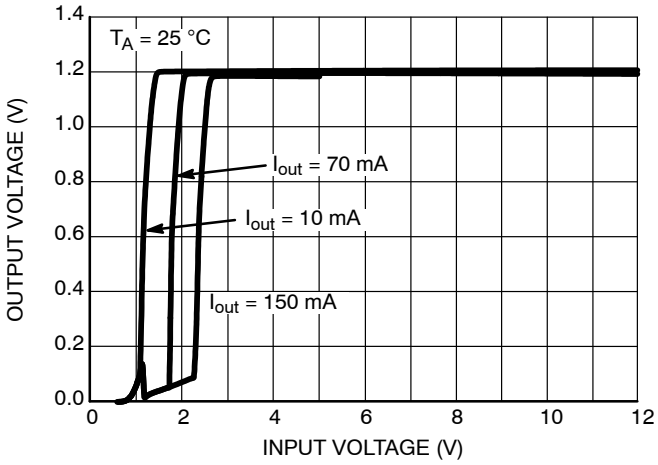


Figure 10. Output Voltage vs. Input Voltage

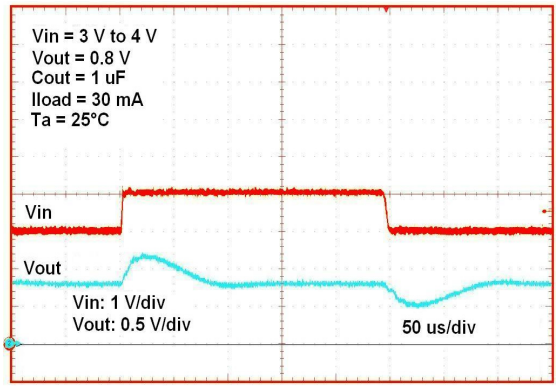


Figure 11. Line Transient Response

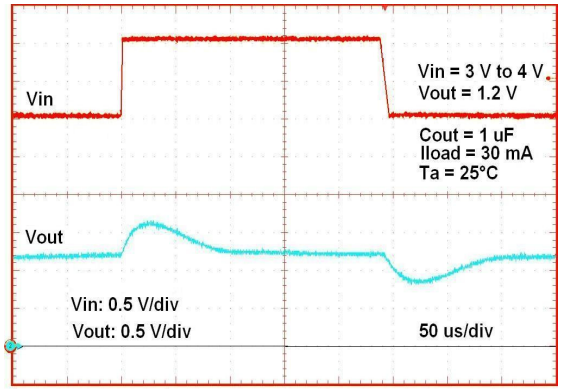


Figure 12. Line Transient Response

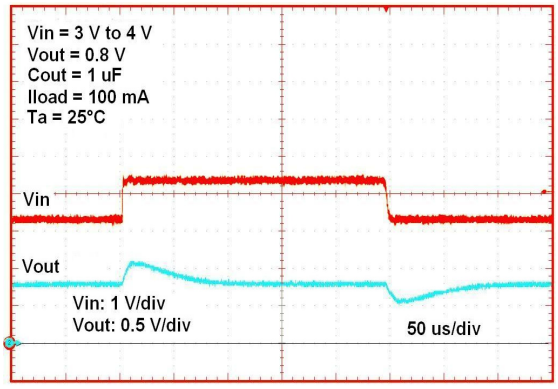


Figure 13. Line Transient Response

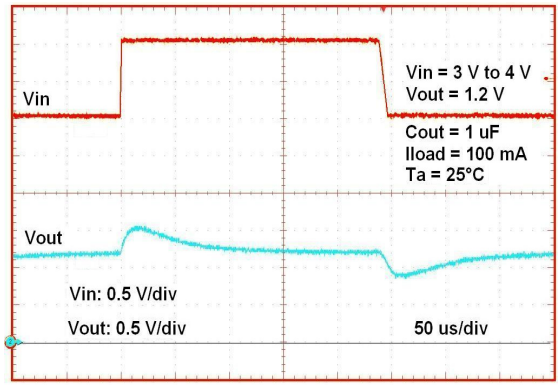


Figure 14. Line Transient Response

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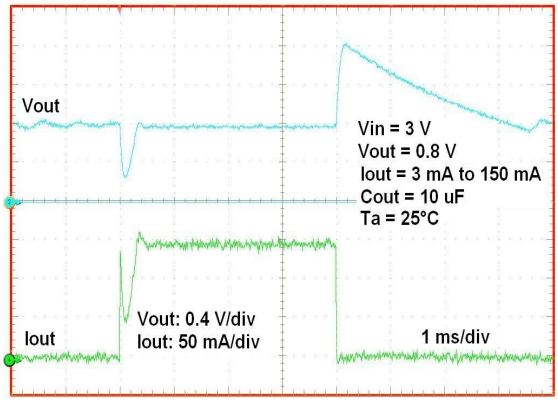


Figure 15. Load Transient Response

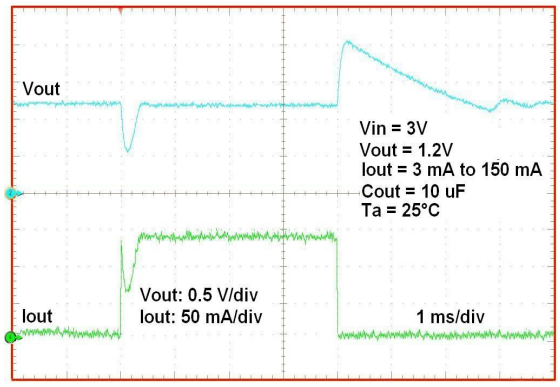


Figure 16. Load Transient Response

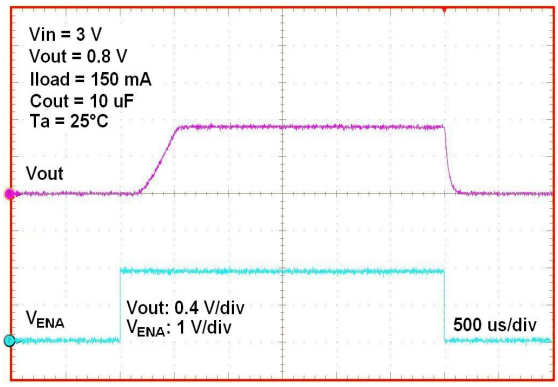


Figure 17. Enable Operation

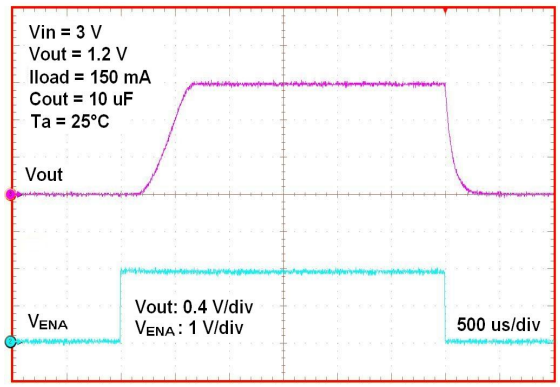


Figure 18. Enable Operation

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APPLICATIONS INFORMATION

A typical application circuit for the NCP571 series is shown in Figure 2.

Input Decoupling (C1)

A 0.1 μF capacitor either ceramic or tantalum is recommended and should be connected close to the NCP571 package. Higher values and lower ESR will improve the overall line transient response.

Output Decoupling (C2)

The NCP571 is a stable Regulator and does not require any specific Equivalent Series Resistance (ESR) or a minimum output current. Capacitors exhibiting ESRs ranging from a few mΩ up to 3.0 Ω can thus safely be used. The minimum decoupling value is 0.1 μF and can be augmented to fulfill stringent load transient requirements. The regulator accepts ceramic chip capacitors as well as tantalum devices. Larger output capacitors can be used without fear of instabilities. Larger values improve noise rejection and load regulation transient response.

Enable Operation

The enable pin will turn on or off the regulator. These limits of threshold are covered in the electrical specification section of this data sheet. If the enable is not used then the pin should be connected to V_{in}. It is not recommended to leave this pin on air. In case the voltage of Enable signal is higher then Input voltage of NCP571 device it is necessary add an resistor divider in order to keep voltage at Enable pin bellow Input voltage. A single gate device of VHC family could be used for this logic level translation. The NL17SZ06 device could be chosen for non inverting open-drain buffer as shown in Figure 19. Other possibility is using NL17SZ16 device as shown in Figure 20. More information is mentioned in Application Note AND8101/D.

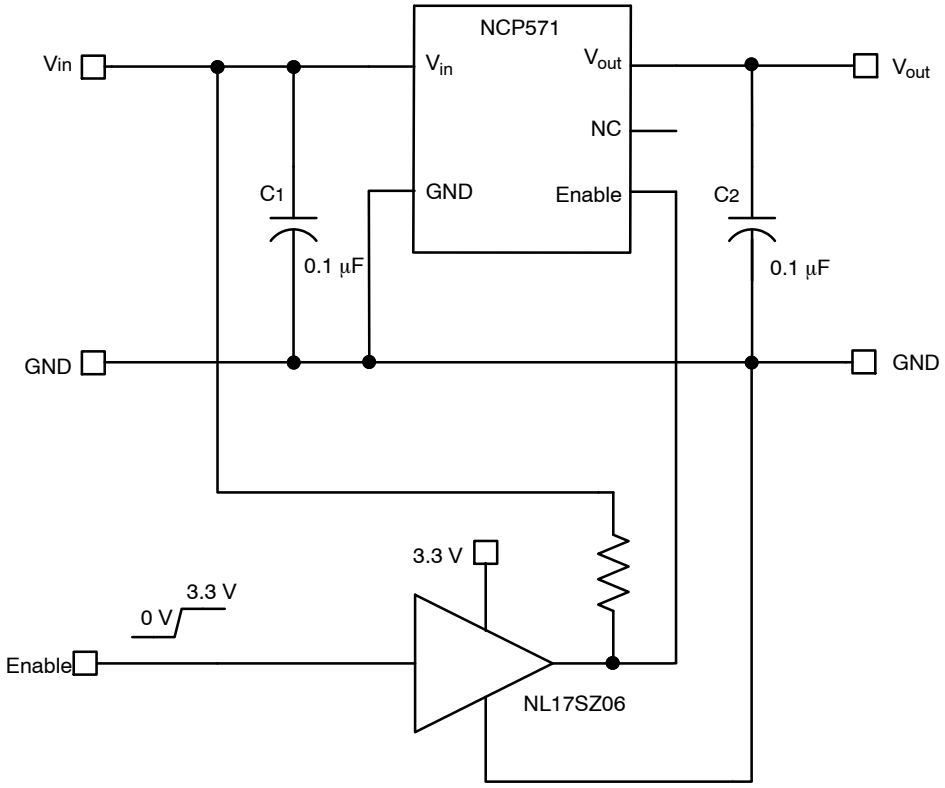


Figure 19.

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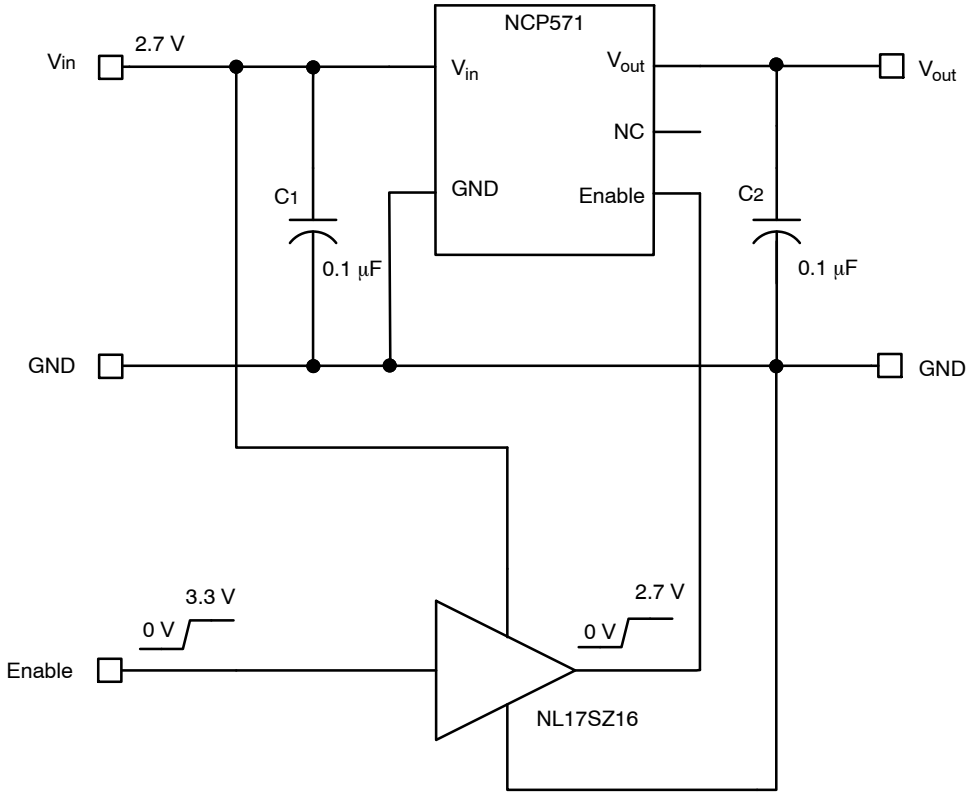


Figure 20.

Hints

Please be sure the V_{in} and GND lines are sufficiently wide. When the impedance of these lines is high, there is a chance to pick up noise or cause the regulator to malfunction.

Set external components, especially the output capacitor, as close as possible to the circuit, and make leads as short as possible.

Thermal

As power across the NCP571 increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and also the ambient temperature effect the rate of temperature rise for the part. This is stating that when the NCP571 has good thermal conductivity through the PCB, the junction temperature will be relatively low with high power dissipation applications.

The maximum dissipation the package can handle is given by:

$$P_D = \frac{T_{J(max)} - T_A}{R_{\theta JA}}$$

If junction temperature is not allowed above the maximum 125 °C, then the NCP571 can dissipate up to 400 mW @ 25 °C.

The power dissipated by the NCP571 can be calculated from the following equation:

$$P_{tot} = V_{in(max)}\left(I_{GND} + I_{out}\right) - V_{out} * I_{out}$$

If a 150 mA output current is needed then the ground current from the data sheet is 4.0 μA.

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ORDERING INFORMATION

Device	Nominal Output Voltage	Marking	Package	Shipping†
NCP571MN08TBG	0.8	AC	DFN6 (Pb-Free)	3,000 / Tape & Reel
NCP571MN12TBG	1.2	AA	DFN6 (Pb-Free)	3,000 / Tape & Reel
NCV571MN10TBG*	1.0	AH	DFN6 (Pb-Free)	3,000 / Tape & Reel
NCV571MN12TBG*	1.2	AJ	DFN6 (Pb-Free)	3,000 / Tape & Reel

DISCONTINUED (Note 7)

NCV571MN09TBG*	0.9	AG	DFN6 (Pb-Free)	3,000 / Tape & Reel
NCP571SN08T1G	0.8	N6A	TSOP-5 (Pb-Free)	3,000 / Tape & Reel
NCP571SN09T1G	0.9	N6E	TSOP-5 (Pb-Free)	3,000 / Tape & Reel
NCP571SN10T1G	1.0	N6C	TSOP-5 (Pb-Free)	3,000 / Tape & Reel
NCP571SN12T1G	1.2	N6D	TSOP-5 (Pb-Free)	3,000 / Tape & Reel
NCV571SN08T1G*	0.8	N6F	TSOP-5 (Pb-Free)	3,000 / Tape & Reel
NCV571SN09T1G*	0.9	N6G	TSOP-5 (Pb-Free)	3,000 / Tape & Reel
NCV571SN10T1G*	1.0	N6H	TSOP-5 (Pb-Free)	3,000 / Tape & Reel
NCV571SN12T1G*	1.2	N6J	TSOP-5 (Pb-Free)	3,000 / Tape & Reel
NCP571MN09TBG	0.9	AD	DFN6 (Pb-Free)	3,000 / Tape & Reel
NCP571MN10TBG	1.0	AE	DFN6 (Pb-Free)	3,000 / Tape & Reel
NCV571MN08TBG*	0.8	AF	DFN6 (Pb-Free)	3,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

* NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

6. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on www.onsemi.com.

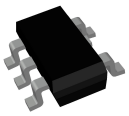
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REVISION HISTORY

Revision	Description of Changes	Date
6	NCV571MN09TBG OPN Marked as Discontinued + Rebranded the Data Sheet to onsemi format.	11/7/2025

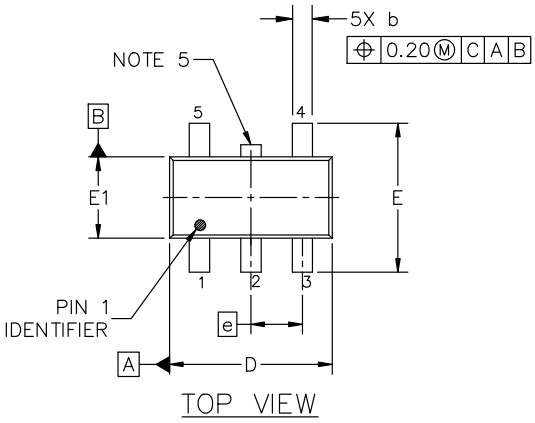
This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.

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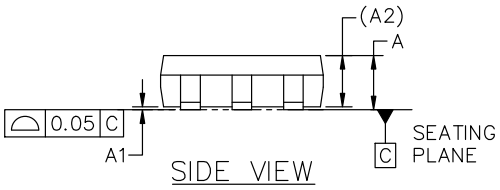


TSOP−5 3.00x1.50x0.95, 0.95P
CASE 483
ISSUE P

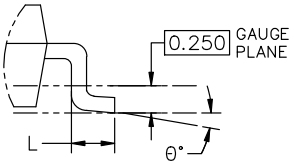
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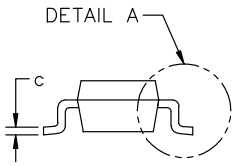
TOP VIEW



SIDE VIEW



DETAIL "A"
SCALE 2:1



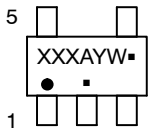
END VIEW

NOTES:

1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5−2018.
2. ALL DIMENSION ARE IN MILLIMETERS (ANGLES IN DEGREES).
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OF GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE. DIMENSION D.
5. OPTIONAL CONSTRUCTION: AN ADDITIONAL TRIMMED LEAD IS ALLOWED IN THIS LOCATION. TRIMMED LEAD NOT TO EXTEND MORE THAN 0.2 FROM BODY.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.900	1.000	1.100
A1	0.010	0.055	0.100
A2		0.950 REF.	
b	0.250	0.375	0.500
c	0.100	0.180	0.260
D	2.850	3.000	3.150
E	2.500	2.750	3.000
E1	1.350	1.500	1.650
e		0.950 BSC	
L	0.200	0.400	0.600
θ	0°	5°	10°

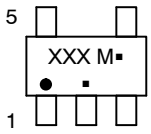
GENERIC
MARKING DIAGRAM*



Analog

XXX = Specific Device Code
A = Assembly Location
Y = Year
W = Work Week
▪ = Pb−Free Package

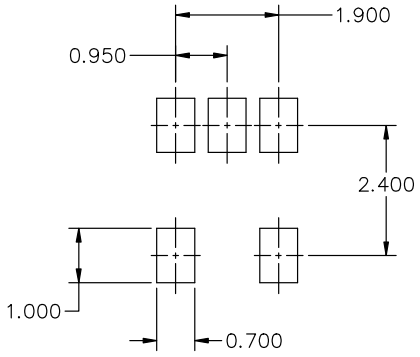
(Note: Microdot may be in either location)



Discrete/Logic

XXX = Specific Device Code
M = Date Code
▪ = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

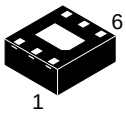


RECOMMENDED MOUNTING FOOTPRINT*

* FOR ADDITIONAL INFORMATION ON OUR Pb−FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

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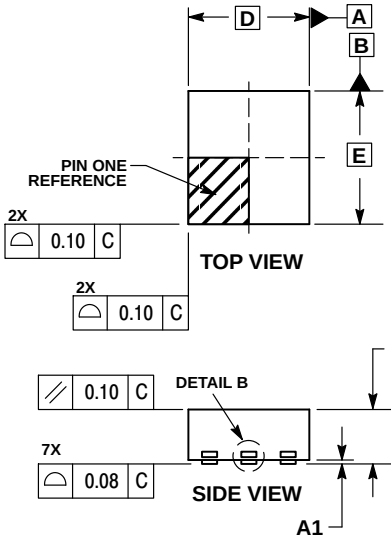
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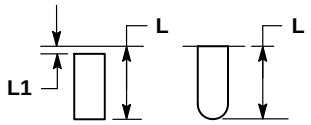


SCALE 4:1

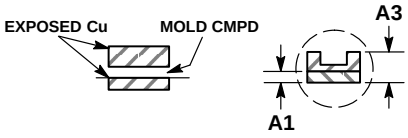
DFN6, 2x2.2, 0.65P
CASE 506BA
ISSUE A

DATE 07 JUL 2008

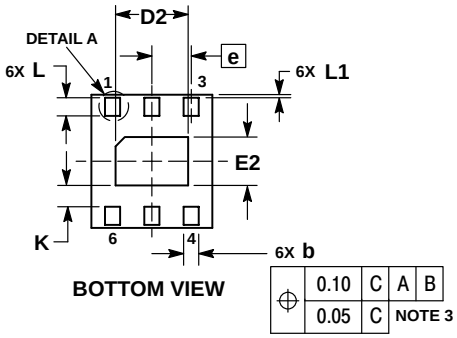




DETAIL A
ALTERNATE TERMINAL CONSTRUCTIONS



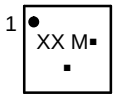
DETAIL B
ALTERNATE CONSTRUCTIONS



NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 mm FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS	
DIM	MIN	MAX
A	0.80	1.00
A1	0.00	0.05
b	0.20	0.30
D	2.00 BSC	
D2	1.10	1.30
E	2.20 BSC	
E2	0.70	0.90
e	0.65 BSC	
K	0.20	---
L	0.25	0.35
L1	0.00	0.10

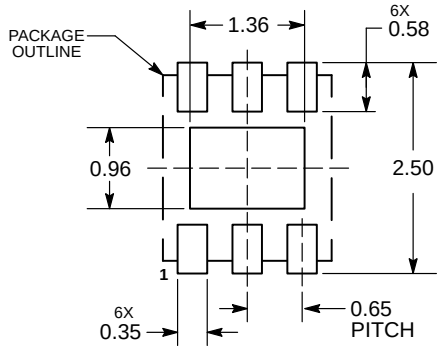
GENERIC MARKING DIAGRAM*



XX = Specific Device Code
M = Date Code
▪ = Pb−Free Device

*This information is generic. Please refer to device data sheet for actual part marking.
Pb−Free indicator, “G” or microdot “ ▪”, may or may not be present.

SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb−Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	**6 PIN DFN, 2.0X2.2, 0.65P**	**PAGE 1 OF 1**

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